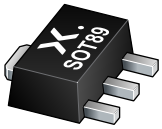


PBHV9540X-Q

400 V, 0.5 A PNP high-voltage low VCEsat transistor

18 July 2023 Product data sheet

1. General description

PNP high-voltage low V_{CEsat} transistor in a SOT89 (SC-62) medium power and flat lead Surface-Mounted Device (SMD) plastic package.

NPN complement: PBHV8540X-Q

2. Features and benefits

- High voltage
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- AEC-Q101 qualified

3. Applications

- Electronic ballast for fluorescent lighting
- LED driver for LED chain module
- LCD backlighting
- High Intensity Discharge (HID) front lighting
- Automotive motor management
- Hook switch for wired telecom
- Switch mode power supply

4. Quick reference data

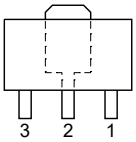
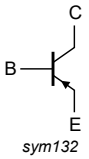
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{CEO}	collector-emitter voltage	open base		-	-	-400	V
I_C	collector current			-	-	-0.5	A
I_{CM}	peak collector current	single pulse; $t_p \leq$ 1 ms		-	-	-1	A
h_{FE}	DC current gain	V_{CE} = -5 V; I_C = -20 mA; T_{amb} = 25 °C		140	-	450	
R_{CEsat}	collector-emitter saturation resistance	I_C = -200 mA; I_B = -40 mA; pulsed; $t_p \leq$ 300 µs; $\delta \leq$ 0.02; T_{amb} = 25 °C		-	-	2000	mΩ

nexperia

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter	 SOT89	 sym132
2	C	collector		
3	B	base		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PBHV9540X-Q	SOT89	plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	SOT89

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PBHV9540X-Q	%4H

[1] % = placeholder for manufacturing site code

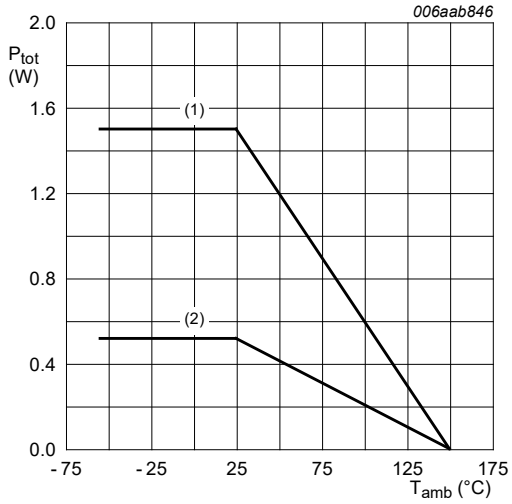
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter		-	-400	V
V_{CEO}	collector-emitter voltage	open base		-	-400	V
V_{CESM}	collector-emitter peak voltage	V_{BE} = 0 V		-	-400	V
V_{EBO}	emitter-base voltage	open collector		-	-7	V
I_C	collector current			-	-0.5	A
I_{CM}	peak collector current	single pulse; $t_p \leq$ 1 ms		-	-1	A
I_B	base current			-	-250	mA
P_{tot}	total power dissipation	$T_{amb} \leq$ 25 °C	[1]	-	0.52	W
			[2]	-	1.5	W
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm^2.



(1) FR4 PCB, mounting pad for collector 6 cm^2
(2) FR4 PCB, standard footprint

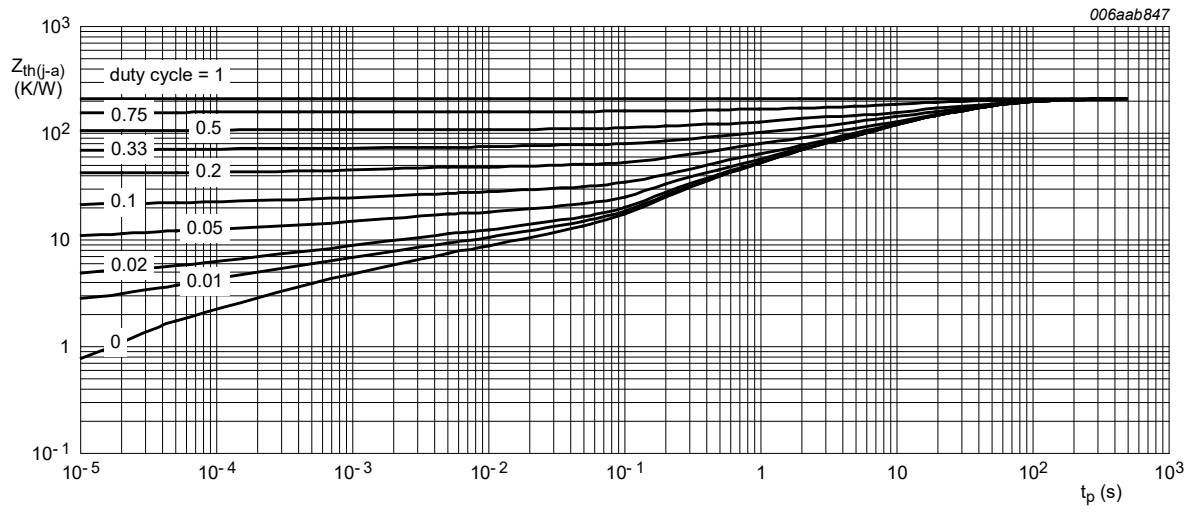
Fig. 1. Power derating curves

9. Thermal characteristics

Table 6. Thermal characteristics

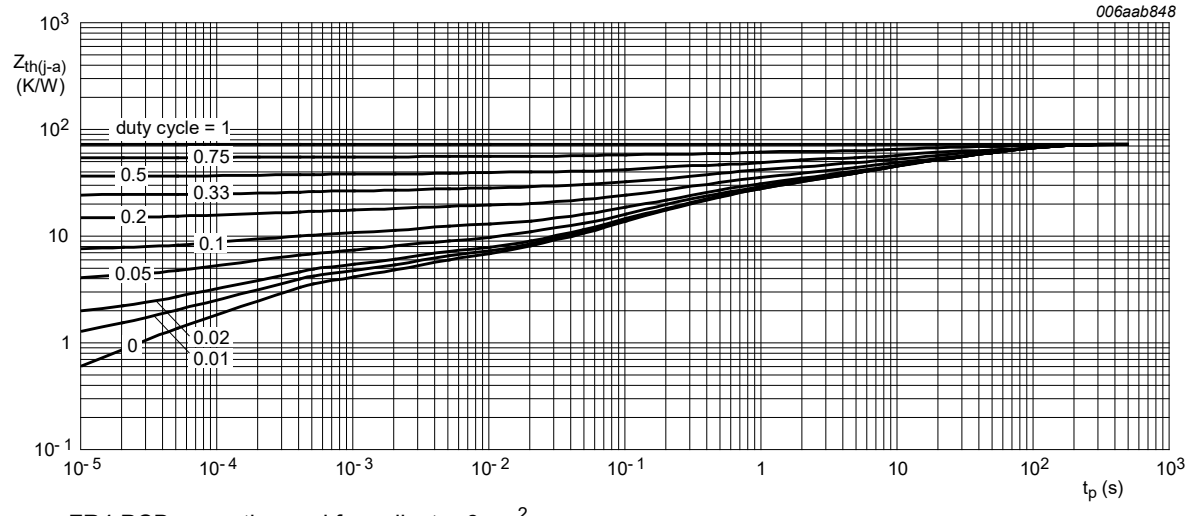
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	240	K/W
			[2]	-	-	83	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	20	-	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm^2.



FR4 PCB, standard footprint

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



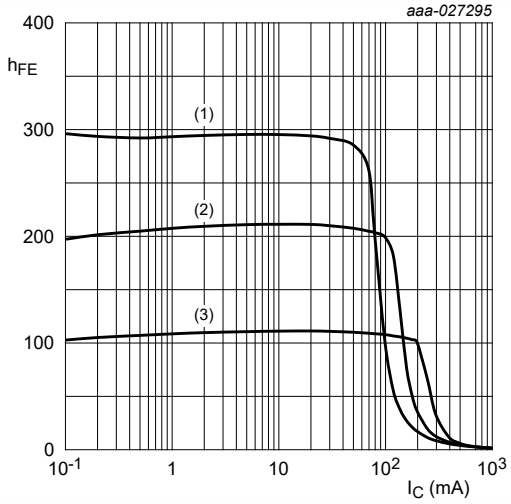
FR4 PCB, mounting pad for collector 6 cm^2

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

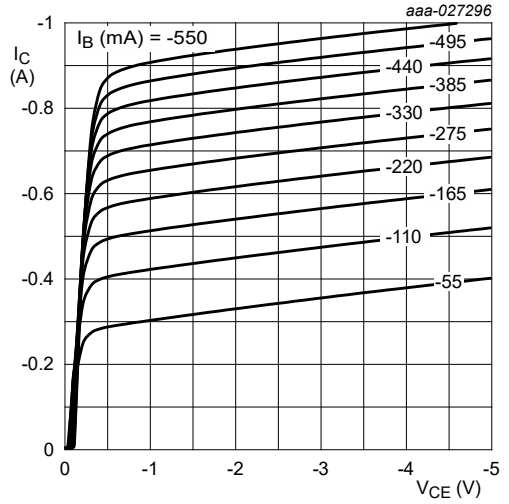
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	I_C = -100 µA; I_E = 0 A; T_{amb} = 25 °C		-400	-	-	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	I_C = -2.5 mA; I_B = 0 A; T_{amb} = 25 °C		-400	-	-	V
$V_{(BR)CES}$	collector-emitter breakdown voltage (base shorted)	I_C = -2.5 mA; V_{BE} = 0 V; T_{amb} = 25 °C		-400	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage (collector open)	I_E = -100 µA; I_C = 0 A; T_{amb} = 25 °C		-7	-	-	V
I_{CBO}	collector-base cut-off current	V_{CB} = -320 V; I_E = 0 A; T_{amb} = 25 °C		-	-	-100	nA
		V_{CB} = -320 V; I_E = 0 A; T_j = 150 °C		-	-	-10	µA
I_{EBO}	emitter-base cut-off current	V_{EB} = -7 V; I_C = 0 A; T_{amb} = 25 °C		-	-	-100	nA
I_{CES}	collector-emitter cut-off current	V_{CE} = -320 V; V_{BE} = 0 V; T_{amb} = 25 °C		-	-	-100	nA
h_{FE}	DC current gain	V_{CE} = -5 V; I_C = -20 mA; T_{amb} = 25 °C		140	-	450	
		V_{CE} = -5 V; I_C = -100 mA; pulsed; $t_p \leq$ 300 µs; δ = 0.02; T_{amb} = 25 °C		140	-	400	
V_{CEsat}	collector-emitter saturation voltage	I_C = -100 mA; I_B = -20 mA; pulsed; $t_p \leq$ 300 µs; δ ≤ 0.02; T_{amb} = 25 °C		-	-	-250	mV
		I_C = -200 mA; I_B = -40 mA; pulsed; $t_p \leq$ 300 µs; δ ≤ 0.02; T_{amb} = 25 °C		-	-	-400	mV
R_{CEsat}	collector-emitter saturation resistance			-	-	2000	mΩ
V_{BEsat}	base-emitter saturation voltage	I_C = -100 mA; I_B = -10 mA; pulsed; $t_p \leq$ 300 µs; δ ≤ 0.02; T_{amb} = 25 °C		-	-	-0.9	V
		I_C = -200 mA; I_B = -40 mA; pulsed; $t_p \leq$ 300 µs; δ ≤ 0.02; T_{amb} = 25 °C		-	-	-1	V
V_{BE}	base-emitter voltage	V_{CE} = -10 V; I_C = -200 mA; pulsed; $t_p \leq$ 300 µs; δ ≤ 0.02; T_{amb} = 25 °C		-	-	-0.9	V
t_d	delay time	V_{CC} = -6.2 V; I_C = -100 mA; I_{Bon} = -10 mA; I_{Boff} = 20 mA; T_{amb} = 25 °C		-	60	-	ns
t_r	rise time			-	3650	-	ns
t_{on}	turn-on time			-	3710	-	ns
t_s	storage time			-	810	-	ns
t_f	fall time			-	900	-	ns
t_{off}	turn-off time			-	1710	-	ns
f_T	transition frequency	V_{CE} = -5 V; I_C = -50 mA; f = 100 MHz; T_{amb} = 25 °C		-	65	-	MHz
C_c	collector capacitance	V_{CB} = -10 V; I_E = 0 A; i_e = 0 A; f = 1 MHz; T_{amb} = 25 °C		-	14	-	pF
C_e	emitter capacitance	V_{EB} = -0.5 V; I_C = 0 A; i_c = 0 A; f = 1 MHz; T_{amb} = 25 °C		-	235	-	pF



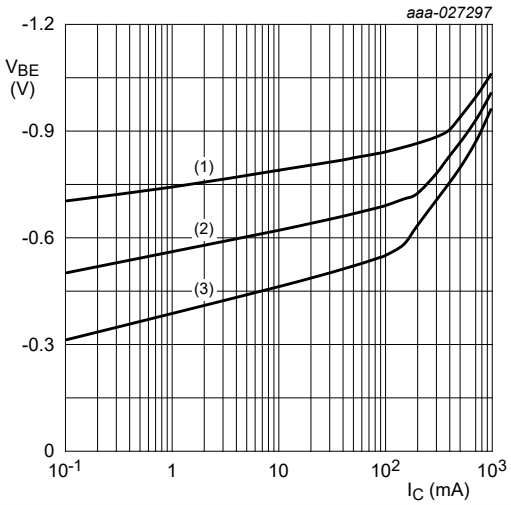
V_{CE} = -5 V
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = -55 °C

Fig. 4. DC current gain as a function of collector current; typical values



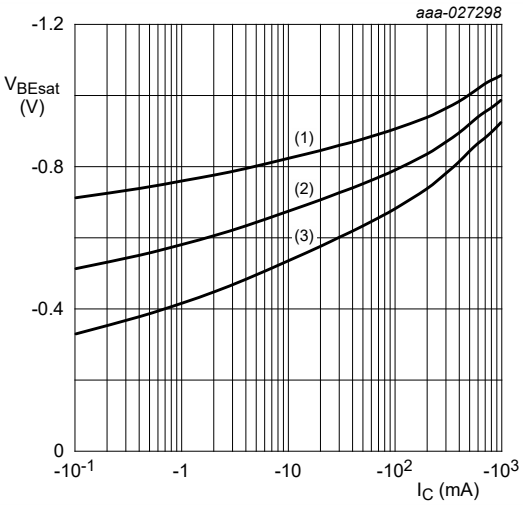
T_{amb} = 25 °C

Fig. 5. Collector current as a function of collector-emitter voltage; typical values



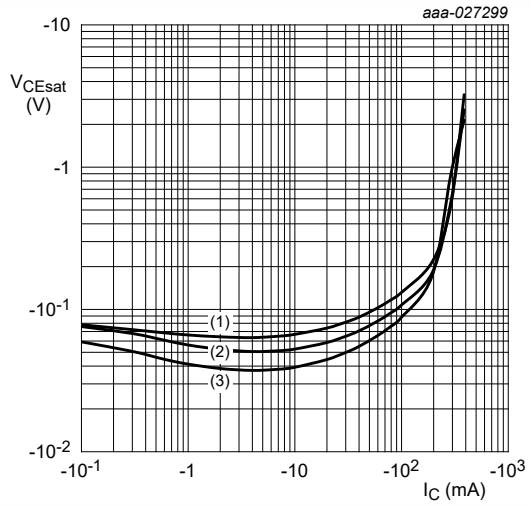
V_{CE} = -5 V
(1) T_{amb} = -55 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = 100 °C

Fig. 6. Base-emitter voltage as a function of collector current; typical values



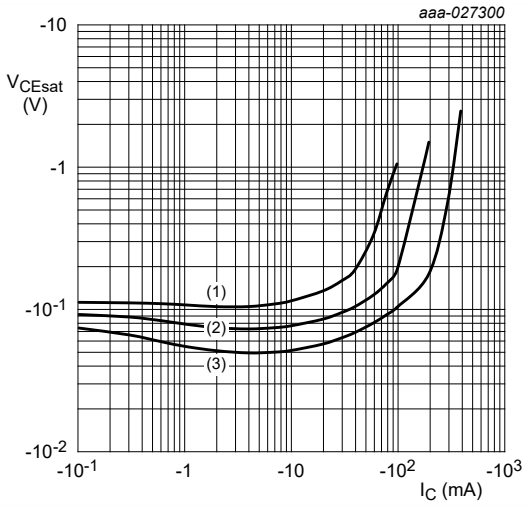
I_C/I_B = 5
(1) T_{amb} = -55 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = 100 °C

Fig. 7. Base-emitter saturation voltage as a function of collector current; typical values



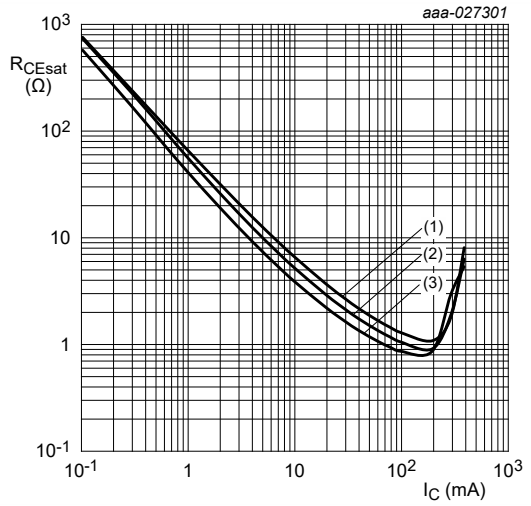
I_C/I_B = 5
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = -55 °C

Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values



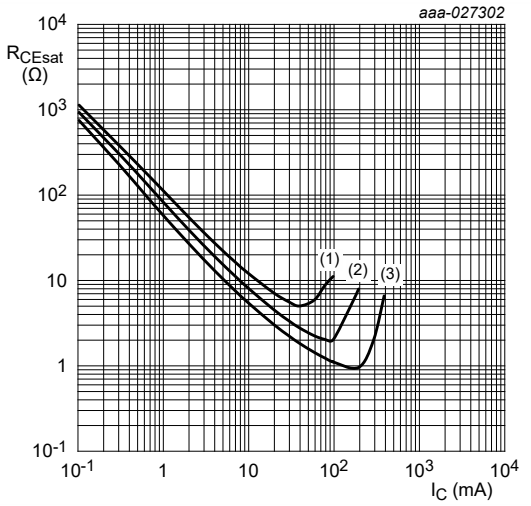
T_{amb} = 25 °C
(1) I_C/I_B = 20
(2) I_C/I_B = 10
(3) I_C/I_B = 5

Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values



I_C/I_B = 5
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = -55 °C

Fig. 10. Collector-emitter saturation resistance as a function of collector current; typical values



T_{amb} = 25 °C
(1) I_C/I_B = 20
(2) I_C/I_B = 10
(3) I_C/I_B = 5

Fig. 11. Collector-emitter saturation resistance as a function of collector current; typical values

11. Test information

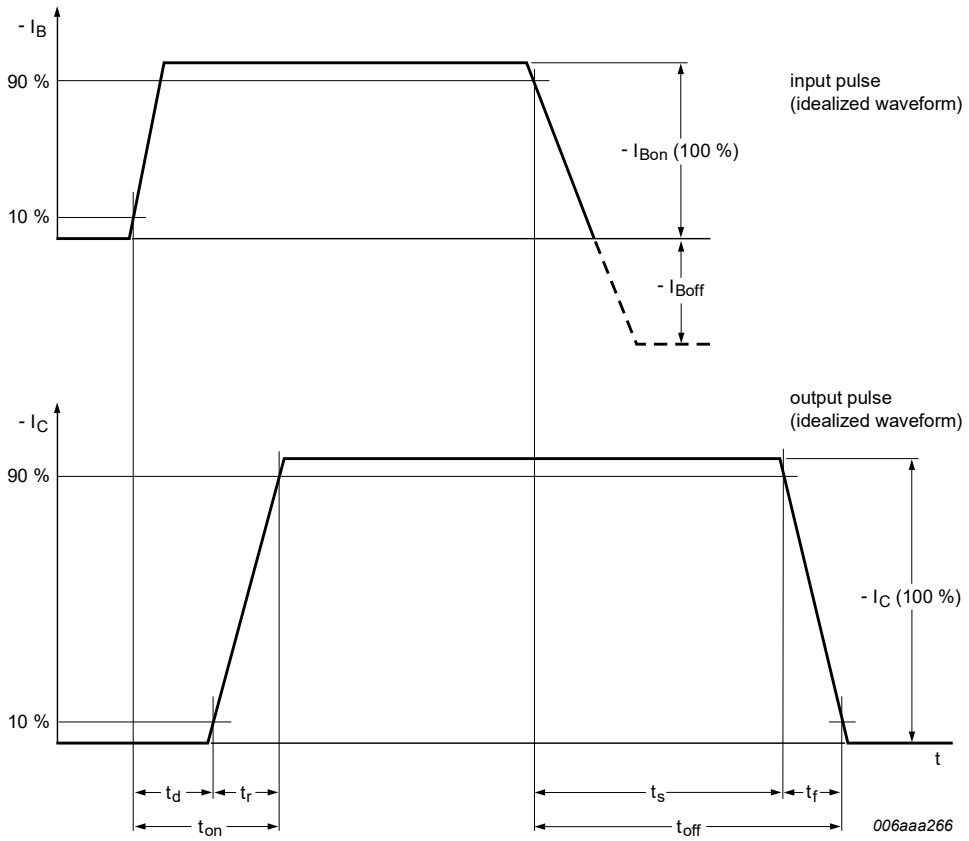


Fig. 12. BISS transistor switching time definition

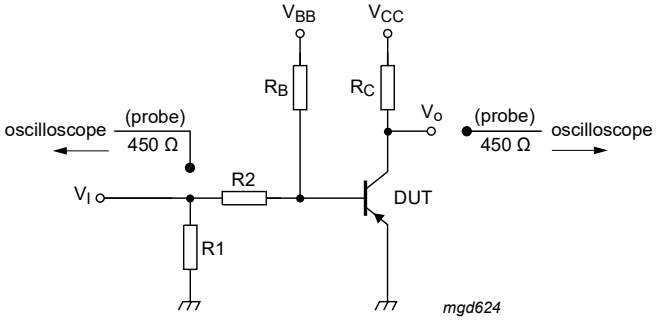


Fig. 13. Test circuit for switching times

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

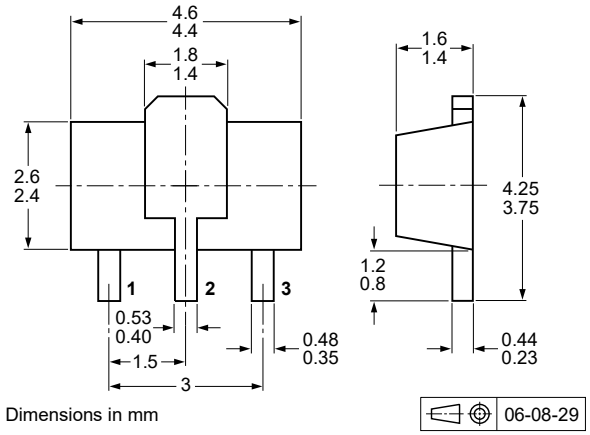


Fig. 14. Package outline SOT89

13. Soldering

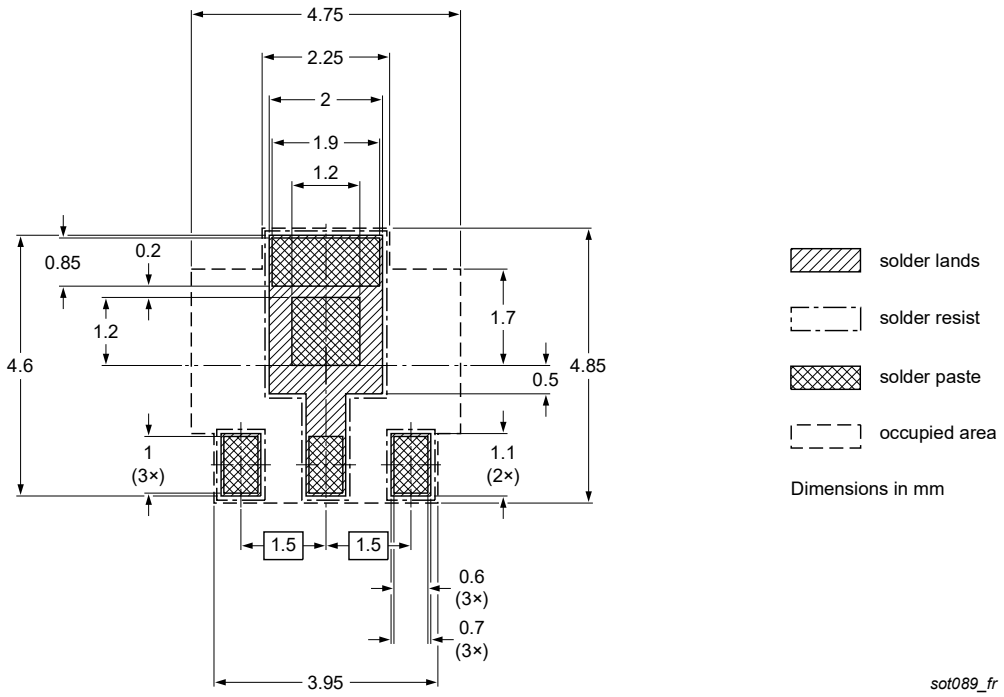


Fig. 15. Reflow soldering footprint for SOT89

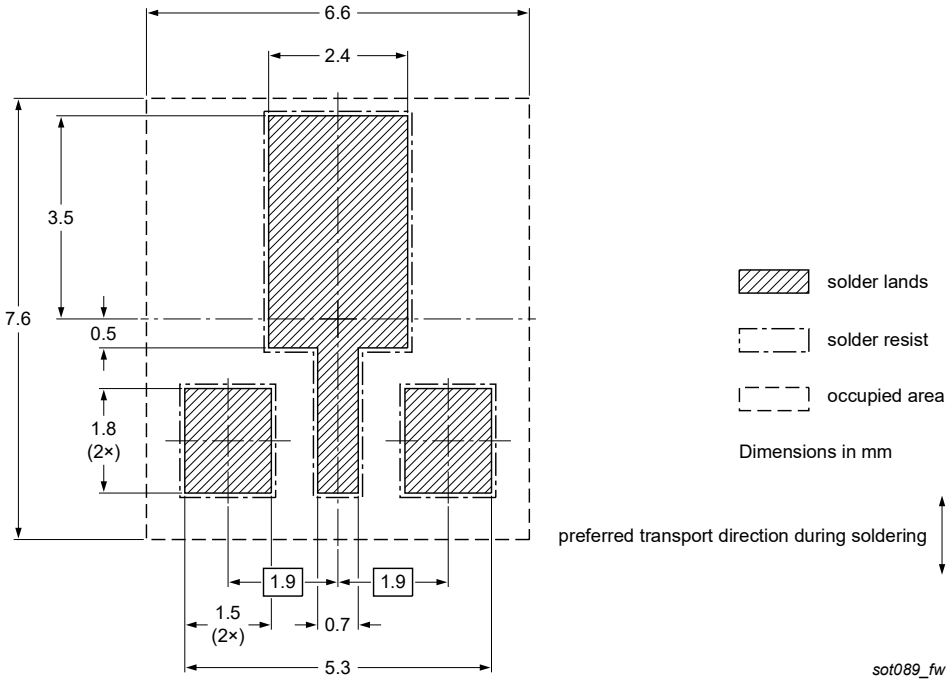


Fig. 16. Wave soldering footprint for SOT89

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBHV9540X-Q v.1	20230718	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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Contents

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Date of release: 18 July 2023

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